

### **NEW** DATA SHEET

# Application

- Thyristors
- Desktop CPU´s
- IGBT units

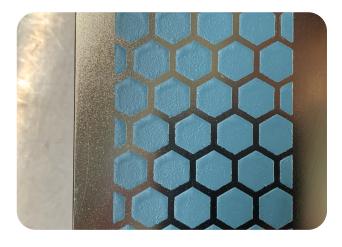
## Benefits

- Filling of smallest irregularities between the power module and heat sink
- Improves the contact between the surfaces and increases the heat transfer
- Good applicability in the form of screen and stencil printing
- Possibility to buy pre assembled parts
- Very low bond line thickness

Properties	Unit	Value
Colour		Titanium blue
Viscosity Brookfield K/P* (Temperature dependent; dried area)	Pas	400/creamy (@40°C) 200 (@50°C) 120 (@60°C) 80 (@80°C) 50 (@100°C)
Thermal conductivity $\boldsymbol{\lambda}$	W/mK	>3.5
Dielectric breakdown E <sub>d</sub>	KV/mm	>]
Operating temperature	°C	-40 to +120
Softening interval	°C	52-54
Possible layer thickness	μm	50-250
Post-curing time (40°C @ 250 µm)**	h	18-24

\* Sheare rate  $\lambda$  4.6s<sup>-1</sup>

\*\* This time is valid for natural convection. If there is some kind of ventilation, the time curing time is lower







### Note

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The specifications provided in this data sheet do not constitute a guarantee or warranty of specific product properties ("quality guarantee"). These specifications are derived from our standardized testing procedures conducted under controlled laboratory conditions and are intended to describe the typical properties of the products as expected under standard applications. Variations may occur depending on the specific application. Accordingly, it is the responsibility of the customer to test and evaluate the products for their intended use, and adjustments to the application may be required.

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